

### Remarks

The Office Action mailed August 8, 2003 has been carefully reviewed and the foregoing amendment has been made in consequence thereof.

Claims 1-8, 11-28, 31-41, 44-54, and 56-60 are now pending in this application. Claims 1-8, 11-28, 31-41, and 44-50 are allowed. Claims 51-54 and 58-60 are rejected. Claims 55-57 are objected to. Claim 55 is canceled.

The rejection of Claims 51-54, and 58 under 35 U.S.C. § 102(b) as being anticipated by LaGrotta et al. (U.S. Patent No. 6,374,912) and the rejection of Claims 58-60 under 35 U.S.C. § 103 as being unpatentable over LaGrotta et al. in view of (U.S. Patent No. 5,946,193) are respectfully traversed. Further, the objection to Claims 55-57 is traversed.

Claim 51 has been amended to include the limitations of former Claim 55, which has been indicated as being allowable, if written in independent form. Hence, Claim 51 is submitted to be patentable over LaGrotta et al.

LaGrotta et al. describe the component parts of a weather resistant cabinet, including a first cover 8, a doorframe 12, a first gasket 13, a tubular housing 1 having a first open end 2 and a second open end 3, and a second cover 14. The second cover 14 is identical in structure to the first cover 8 and both are generally shaped as a flat, rectangular plate.

Hendrix describes an equipment enclosure 5 having a polymer shell 7. A heat conductive piece 9 has two set of heat transfer fins 9a fitting respectively in the two holes 7a in the polymer shell 7. The heat conductive pieces fit in a sealed relationship in the openings 9a. More particularly, two gaskets, 11, 13 are provided for sealing the heat conductive piece 9 to the polymer shell 7. An O-ring gasket 11 fits within a groove formed in the heat conductive piece 9 and against a flat surface of the polymer shell 7. One O-ring gasket 11 surrounds each set of heat transfer fins 9a. The O-ring gasket 11 is for a water tight seal. The polymer shell 7 is sealed

with a cover 51. The cover 51 is gasketed in the same manner as the heat conductive pieces 9. The polymer shell 7 has hinge extensions 57 which are molded integrally with the polymer shell 7. Hinge portions 59 on the cover 51 receive the hinge extensions 57 on the polymer shell 7.

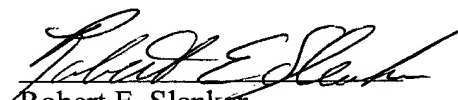
Claim 58 recites an enclosure for electronic components which comprises "a housing comprising an interior portion and an opening formed in said housing into said interior portion, said housing comprising separate top and bottom pieces, said top and bottom pieces sealed to one another, said housing being adapted to prevent water from entering said interior portion," "a door attached to said housing, said door sealably covering said opening and being moveable between open and closed positions" and "a heat sink sealably coupled to an exterior of said housing, wherein said heat sink transfers heat from said interior portion to the external environment."

LaGrotta et al. in view of Hendrix neither shows nor describes a housing having separate top and bottom pieces, sealed to one another, that is adapted to prevent water from entering an interior portion. Therefore, Applicant submits that Claim 58 is patentable over the cited art.

For the reasons set forth above, Applicant respectfully requests that the rejections of and the objections to the Claims be withdrawn.

In view of the foregoing amendments and remarks, all the claims now active in this application are believed to be in condition for allowance. Reconsideration and favorable action is respectfully solicited.

Respectfully Submitted,

  
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